# **DDR 2-Amp Source / Sink** V<sub>TT</sub> Termination Regulator

The NCP/NCV51199 is a linear regulator designed to supply a regulated V<sub>TT</sub> termination voltage for DDR–2 and DDR–3 memory applications. The regulator is capable of actively sourcing and sinking  $\pm 2$  A peak currents for DDR–2, and DDR–3 up to  $\pm 1.5$  A while regulating the V<sub>TT</sub> output voltage to within  $\pm 10$  mV. The output termination voltage is regulated to track V<sub>DDQ</sub> / 2 by two external voltage divider resistors connected to the PV<sub>CC</sub>, GND, and V<sub>REF</sub> pins.

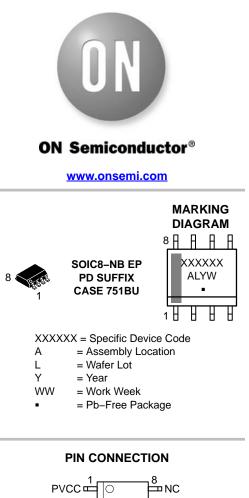
The NCP/NCV51199 incorporates a high-speed differential amplifier to provide ultra-fast response to line and load transients. Other features include source/sink current limiting, soft-start and on-chip thermal shutdown protection.

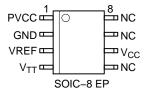
#### Features

- Supports DDR-2 V<sub>TT</sub> Termination to  $\pm 2$  A, DDR-3 to  $\pm 1.5$  A (peak)
- Stable with 10 µF Ceramic Capacitance on V<sub>TT</sub> Output
- Integrated Power MOSFETs
- High Accuracy V<sub>TT</sub> Output at Full-Load
- Fast Transient Response
- Built-in Soft-Start
- Shutdown for Standby or Suspend Mode
- Integrated Thermal and Current-Limit Protection
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### **Typical Applications**

- SDRAM Termination Voltage for DDR-2 / DDR-3
- Motherboard, Notebook, and VGA Card Memory Termination
- Set Top Box, Digital TV, Printers





#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

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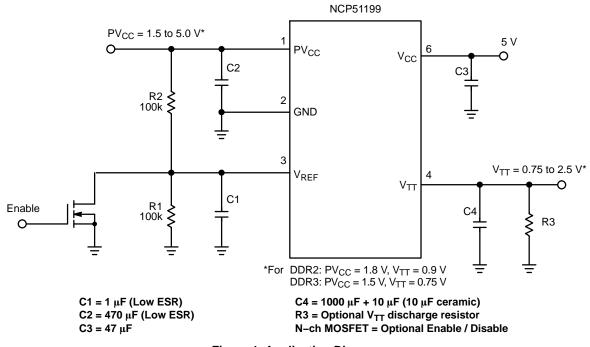


Figure 1. Application Diagram

#### **PIN FUNCTION DESCRIPTION**

Pin No.	Pin Name	Description
1	PV <sub>CC</sub>	Input voltage which supplies current to the output pin. $C_{IN}$ = 470 µF with low ESR.
2	GND	Common Ground
3	V <sub>REF</sub>	Buffered reference voltage input equal to $\frac{1}{2}$ of V <sub>DDQ</sub> and active low shutdown pin. An external resistor divider dividing down the PV <sub>CC</sub> voltage creates the regulated output voltage. Pulling the pin to ground (0.15 V maximum) turns the device off.
4	V <sub>TT</sub>	Regulator output voltage capable of sourcing and sinking current while regulating the output rail. $C_{OUT}$ = 1000 µF + 10 µF ceramic with low ESR.
5	NC	True No Connect
6	V <sub>cc</sub>	The V <sub>CC</sub> pin is a 5 V input pin that provides internal bias to the controller. $PV_{CC}$ should always be kept lower or equal to V <sub>CC</sub> .
7	NC	True No Connect
8	NC	True No Connect
EP	Thermal Pad	Pad for thermal connection. The exposed pad must be connected to the ground plane using multiple vias for maximum power dissipation performance.

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Input Supply Voltage Range ( $V_{cc} \ge PV_{CC}$ ) (Note 1)	PV <sub>CC</sub> , V <sub>CC</sub>	-0.3 to 6	V
Output Voltage Range	V <sub>TT</sub>	–0.3 to 6	V
Reference Input Range	V <sub>REF</sub>	–0.3 to 6	V
Maximum Junction Temperature	T <sub>J(max)</sub>	125	°C
Storage Temperature Range	TSTG	-65 to 150	°C
ESD Capability, Human Body Model (Note 2)	ESDHBM	2	kV
ESD Capability, Machine Model (Note 2)	ESDMM	150	V
Lead Temperature Soldering Reflow (SMD Styles Only), Pb–Free Versions (Note 3)	T <sub>SLD</sub>	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.
This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114)

ESD Machine Model tested per AEC-Q100-003 (EIA/JESD22-A115)

Latchup Current Maximum Rating: ≤150 mA per JEDEC standard: JESD78

3. For information, please refer to our Soldering and Mounting Techniques Reference Manual, SOLDERRM/D

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Characteristics, SO8–EP (Note 4) Thermal Resistance, Junction–to–Air (Note 5) Power Rating at 25°C Ambient = 1.19 W, derate 12 mW/°C	$R_{\thetaJA}$	84	°C/W
Thermal Reference, Junction-to-Lead2 (Note 5)	$R_{\PsiJL}$	20	

4. Refer to ELECTRICAL CHARACTERISTIS and APPLICATION INFORMATION for Safe Operating Area.

5. Values based on copper area of 645 mm<sup>2</sup> (or 1 in<sup>2</sup>) of 1 oz copper thickness and FR4 PCB substrate.

#### **OPERATING RANGES** (Note 6)

Rating	Symbol	Min	Max	Unit
Input Voltage	PV <sub>CC</sub>	1.5	5.5	V
Bias Supply Voltage	V <sub>CC</sub>	4.75	5.25	V
Ambient Temperature	T <sub>A</sub>	-40	85	°C
Junction Temperature	TJ	-40	125	°C

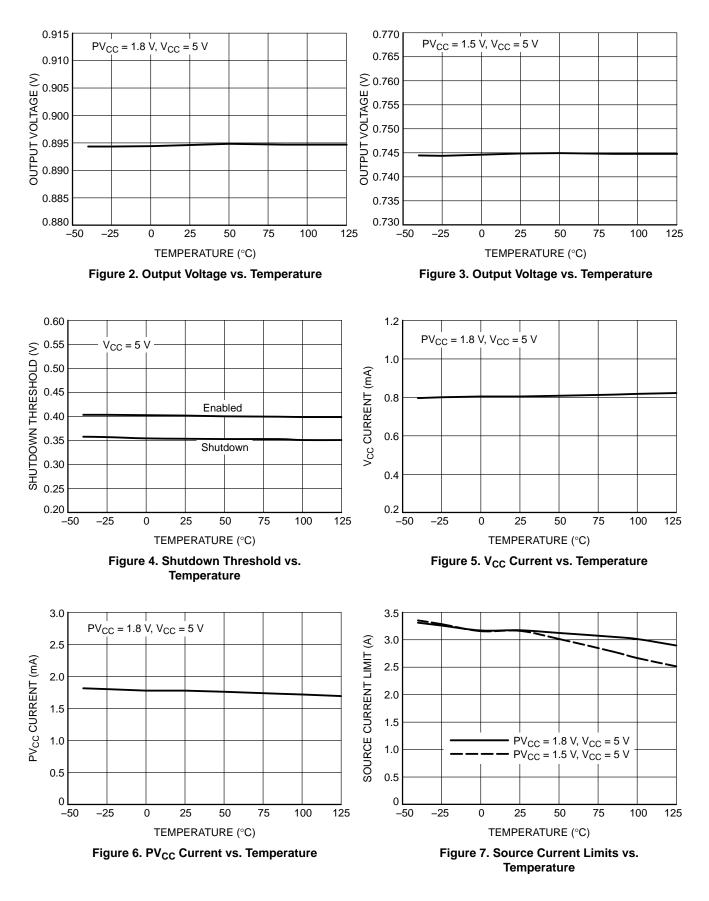
6. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

#### ELECTRICAL CHARACTERISTICS

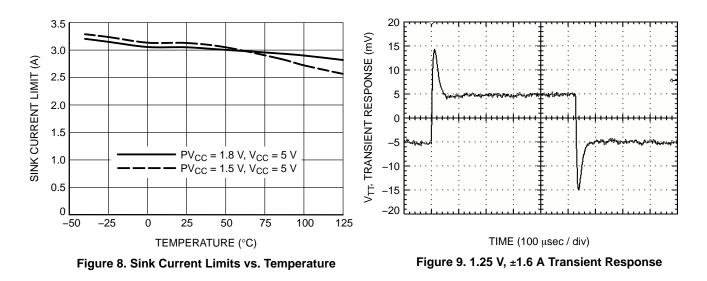
 $PV_{CC} = 1.8 \text{ V} / 1.5 \text{ V}; V_{CC} = 5 \text{ V}; V_{REF} = 0.9 \text{ V} / 0.75 \text{ V}; C_{OUT} = 10 \text{ } \mu\text{F} \text{ (Ceramic)}; T_{A} = +25^{\circ}\text{C}, \text{ unless otherwise noted}.$ 

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit	
REGULATOR OUTPUT							
Output Offset Voltage	utput Offset Voltage I <sub>out</sub> = 0 A		-20	-	+20	mV	
Load Regulation	$V_{REF} = 900 \text{ mV}, I_{out} = \pm 1.8 \text{ A}, PV_{CC} = 1.8 \text{ V}$ $V_{REF} = 750 \text{ mV}, I_{out} = \pm 1.4 \text{ A}, PV_{CC} = 1.5 \text{ V}$	Reg <sub>load</sub>	-10	_	+10	mV	
INPUT AND STANDBY CURREN	TS		-				
Bias Supply Current	Bias Supply Current I <sub>out</sub> = 0 A		-	0.8	2.5	mA	
Standby Current	$V_{\sf REF}$ < 0.2 V (Shutdown), $R_{\sf LOAD}$ = 180 $\Omega$		-	1	90	μΑ	
CURRENT LIMIT PROTECTION							
Ourseast Lissit	$PV_{CC} = 1.8 \text{ V}, \text{ V}_{REF} = 0.9 \text{ V}$		2.0	-	3.5	A	
Current Limit	$PV_{CC} = 1.5 \text{ V}, V_{REF} = 0.75 \text{ V}$	ILIM	1.5	-	3.5		
SHUTDOWN THRESHOLDS							
Oburt day, and There also had by failing and	Enable	V <sub>IH</sub>	0.6	-	-		
Shutdown Threshold Voltage	Shutdown	V <sub>IL</sub>	-	-	0.15	5 V	
THERMAL SHUTDOWN							
Thermal Shutdown Temperature	tdown Temperature V <sub>CC</sub> = 5 V		160	168	176	°C	
Thermal Shutdown Hysteresis V <sub>CC</sub> = 5 V		T <sub>SH</sub>	35	35	40	°C	

### **TYPICAL CHARACTERISTICS**



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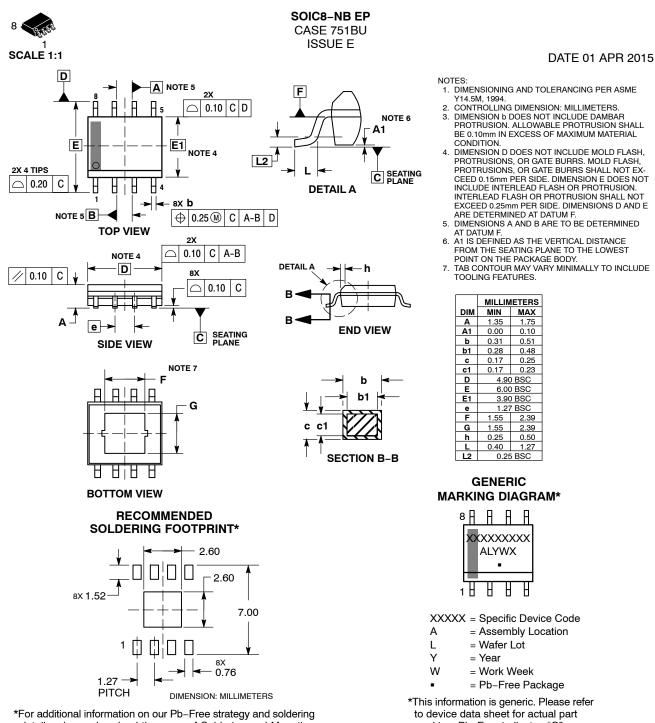


#### **Table 1. ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
NCP51199PDR2G	51199	SOIC-8	2500 / Tape & Reel
NCV51199PDR2G*	V51199	(Pb-Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable.



details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D. to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

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DESCRIPTION:	SOIC8-NB EP		PAGE 1 OF 1		

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